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U.S. UTILITY Patent Application

PATENT NUMBER and ISSUE DATE

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APPL NUM	FILING DATE	CLASS	SUBCLASS	1 1		EXAMINER		11				
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APPLICANT	S: Yamaki	Hiroshi;				11-2						
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**CONTINUING DATA VERIFIED: This application is a 371 of PCT/JP01/04958 05/31/2000												
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** FOREION	ADDITION TO NO. 12	EDIFIER										
** FOREIGN APPLICATIONS VERIFIED: JAPAN 2000-177820 06/14/2000												
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Verified and Ack	nowledged Examiners's				0649	9-0835P		_				
TITLE : Metho	od of injection mold	ing of the	ermoplastic res	sin	U.S.E	DEPT. OF COMM./PAT.& TM-P	IO-436L(Rev. 12	94)				
			 									
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NOTICE OF ALLOWANCE MAILED			CLAIMS ALLOWED				
		Assistant Examiner	Total Claims		Print Claim for O.G		
ISSUE FEE			DRAWING				
Amount Due .	Date Paid		Sheets Drwg. Figs.Drw		rg. Print Fig.		
		Primary Examiner					
TERMINAL DISCLAMER		PREPARED FOR ISSUE	Application Examiner				
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